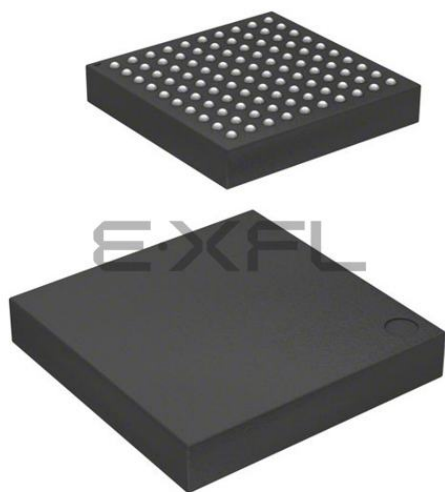




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"[Embedded - Microcontrollers](#)" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

Applications of "[Embedded - Microcontrollers](#)"

Details

Product Status	Active
Core Processor	RXv2
Core Size	32-Bit Single-Core
Speed	120MHz
Connectivity	CANbus, EBI/EMI, Ethernet, I ² C, LINbus, MMC/SD, QSPI, SCI, SPI, UART/USART, USB
Peripherals	DMA, LVD, POR, PWM, WDT
Number of I/O	78
Program Memory Size	2MB (2M x 8)
Program Memory Type	FLASH
EEPROM Size	32K x 8
RAM Size	640K x 8
Voltage - Supply (Vcc/Vdd)	2.7V ~ 3.6V
Data Converters	A/D 22x12b; D/A 1x12b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	100-TFLGA
Supplier Device Package	100-TFLGA (7x7)
Purchase URL	https://www.e-xfl.com/product-detail/renesas-electronics-america/r5f565neddlj-20

1. Overview

1.1 Outline of Specifications

Table 1.1 lists the specifications in outline, and Table 1.2 give a comparison of the functions of products in different packages.

Table 1.1 is an outline of maximum specifications, and the peripheral modules and the number of channels of the modules differ depending on the number of pins on the package and the capacity of the code flash memory. For details, see Table 1.2, Code Flash Memory Capacity and Comparison of Functions for Different Packages.

Table 1.1 Outline of Specifications (1/9)

Classification	Module/Function	Description
CPU	CPU	- Maximum operating frequency: 120 MHz 32-bit RX CPU (RXv2) - Minimum instruction execution time: One instruction per state (cycle of the system clock) - Address space: 4-Gbyte linear - Register set of the CPU - General purpose: Sixteen 32-bit registers - Control: Ten 32-bit registers - Accumulator: Two 72-bit registers - Basic instructions: 75 - Floating-point instructions: 11 - DSP instructions: 23 - Addressing modes: 11 - Data arrangement - Instructions: Little endian - Data: Selectable as little endian or big endian - On-chip 32-bit multiplier: $32 \times 32 \rightarrow 64$ bits - On-chip divider: $32 / 32 \rightarrow 32$ bits - Barrel shifter: 32 bits
	FPU	- Single precision (32-bit) floating point - Data types and floating-point exceptions in conformance with the IEEE754 standard
Memory	Code flash memory	- Capacity: 512 Kbytes/768 Kbytes/1 Mbyte/1.5 Mbytes/2 Mbytes $50 \text{ MHz} \leq$ No-wait cycle access $100 \text{ MHz} \leq$ 1-wait cycle access $100 \text{ MHz} \geq$ 2-wait cycle access - Instructions hitting the ROM cache or operand = 120 MHz: No-wait access - On-board programming: Four types - Off-board programming (parallel programmer mode) - Instructions are executable only for the program stored in the TM target area by using the Trusted Memory (TM) function and protection against data reading is realized. - A dual-bank structure allows programming during reading or exchanging the start-up areas
	Data flash memory	- Capacity: 32 Kbytes - Programming/erasing: 100,000 times
	RAM	- Capacity: 256 Kbytes (Products with 1 Mbyte of code flash memory or less) - RAM: 256 Kbytes - Capacity: 640 Kbytes (Products with at least 1.5 Mbytes of code flash memory) - RAM: 256 Kbytes - Expansion RAM: 384 Kbytes 120 MHz, no-wait access
	Standby RAM	- Capacity: 8 Kbytes - Operation synchronized with PCLKB: Up to 60 MHz, two-cycle access

1.2 List of Products

Table 1.3 is a list of products, and Figure 1.1 shows how to read the product part no.

Table 1.3 List of Products (1/8)

Group	Part No.	Package	Code Flash Memory Capacity (byte(s))	RAM Capacity (byte(s))	Data Flash Memory Capacity (byte(s))	Operating Frequency (Max.)	Encryption Module	SDHI/SDSI	Dual bank	Operating temperature (°C)
RX65N (D version)	R5F565NEDDFC	PLQP0176KB-A	2 M	640 K	32 K	120 MHz	Not available	Available	Available	−40 to +85
	R5F565NEHDFC	PLQP0176KB-A	2 M	640 K	32 K	120 MHz	Available	Available	Available	−40 to +85
	R5F565NCDDFC	PLQP0176KB-A	1.5 M	640 K	32 K	120 MHz	Not available	Available	Available	−40 to +85
	R5F565NCHDFC	PLQP0176KB-A	1.5 M	640 K	32 K	120 MHz	Available	Available	Available	−40 to +85
	R5F565NEDDFB	PLQP0144KA-B	2 M	640 K	32 K	120 MHz	Not available	Available	Available	−40 to +85
	R5F565NEHDFB	PLQP0144KA-B	2 M	640 K	32 K	120 MHz	Available	Available	Available	−40 to +85
	R5F565NCDDFB	PLQP0144KA-B	1.5 M	640 K	32 K	120 MHz	Not available	Available	Available	−40 to +85
	R5F565NCHDFB	PLQP0144KA-B	1.5 M	640 K	32 K	120 MHz	Available	Available	Available	−40 to +85
	R5F565N9ADFB	PLQP0144KA-B	1 M	256 K	Not included	120 MHz	Not available	Not available	Not available	−40 to +85
	R5F565N9BDFB	PLQP0144KA-B	1 M	256 K	Not included	120 MHz	Not available	Available	Not available	−40 to +85
	R5F565N9EDFB	PLQP0144KA-B	1 M	256 K	Not included	120 MHz	Available	Not available	Not available	−40 to +85
	R5F565N9FDFB	PLQP0144KA-B	1 M	256 K	Not included	120 MHz	Available	Available	Not available	−40 to +85
	R5F565N7ADFB	PLQP0144KA-B	768 K	256 K	Not included	120 MHz	Not available	Not available	Not available	−40 to +85
	R5F565N7BDFB	PLQP0144KA-B	768 K	256 K	Not included	120 MHz	Not available	Available	Not available	−40 to +85
	R5F565N7EDFB	PLQP0144KA-B	768 K	256 K	Not included	120 MHz	Available	Not available	Not available	−40 to +85
	R5F565N7FDFB	PLQP0144KA-B	768 K	256 K	Not included	120 MHz	Available	Available	Not available	−40 to +85
	R5F565N4ADFB	PLQP0144KA-B	512 K	256 K	Not included	120 MHz	Not available	Not available	Not available	−40 to +85
	R5F565N4BDFB	PLQP0144KA-B	512 K	256 K	Not included	120 MHz	Not available	Available	Not available	−40 to +85
	R5F565N4EDFB	PLQP0144KA-B	512 K	256 K	Not included	120 MHz	Available	Not available	Not available	−40 to +85
	R5F565N4FDFB	PLQP0144KA-B	512 K	256 K	Not included	120 MHz	Available	Available	Not available	−40 to +85
	R5F565NEDDFP	PLQP0100KB-B	2 M	640 K	32 K	120 MHz	Not available	Available	Available	−40 to +85
	R5F565NEHDFP	PLQP0100KB-B	2 M	640 K	32 K	120 MHz	Available	Available	Available	−40 to +85
	R5F565NCDDFP	PLQP0100KB-B	1.5 M	640 K	32 K	120 MHz	Not available	Available	Available	−40 to +85
	R5F565NCHDFP	PLQP0100KB-B	1.5 M	640 K	32 K	120 MHz	Available	Available	Available	−40 to +85
	R5F565N9ADFP	PLQP0100KB-B	1 M	256 K	Not included	120 MHz	Not available	Not available	Not available	−40 to +85
	R5F565N9BDFP	PLQP0100KB-B	1 M	256 K	Not included	120 MHz	Not available	Available	Not available	−40 to +85
	R5F565N9EDFP	PLQP0100KB-B	1 M	256 K	Not included	120 MHz	Available	Not available	Not available	−40 to +85
	R5F565N9FDFP	PLQP0100KB-B	1 M	256 K	Not included	120 MHz	Available	Available	Not available	−40 to +85

1.3 Block Diagram

Figure 1.2 shows a block diagram.

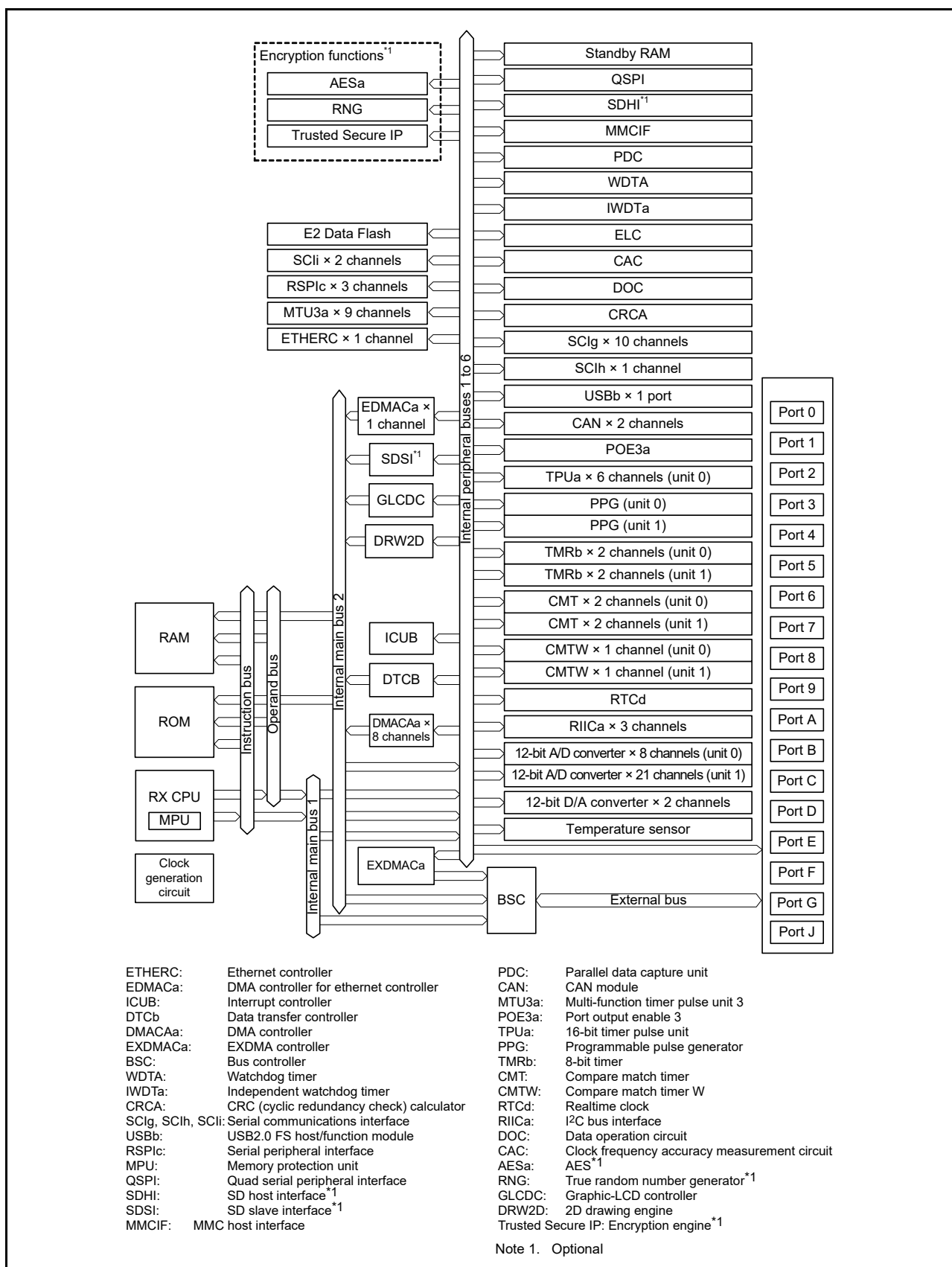


Figure 1.2 Block Diagram

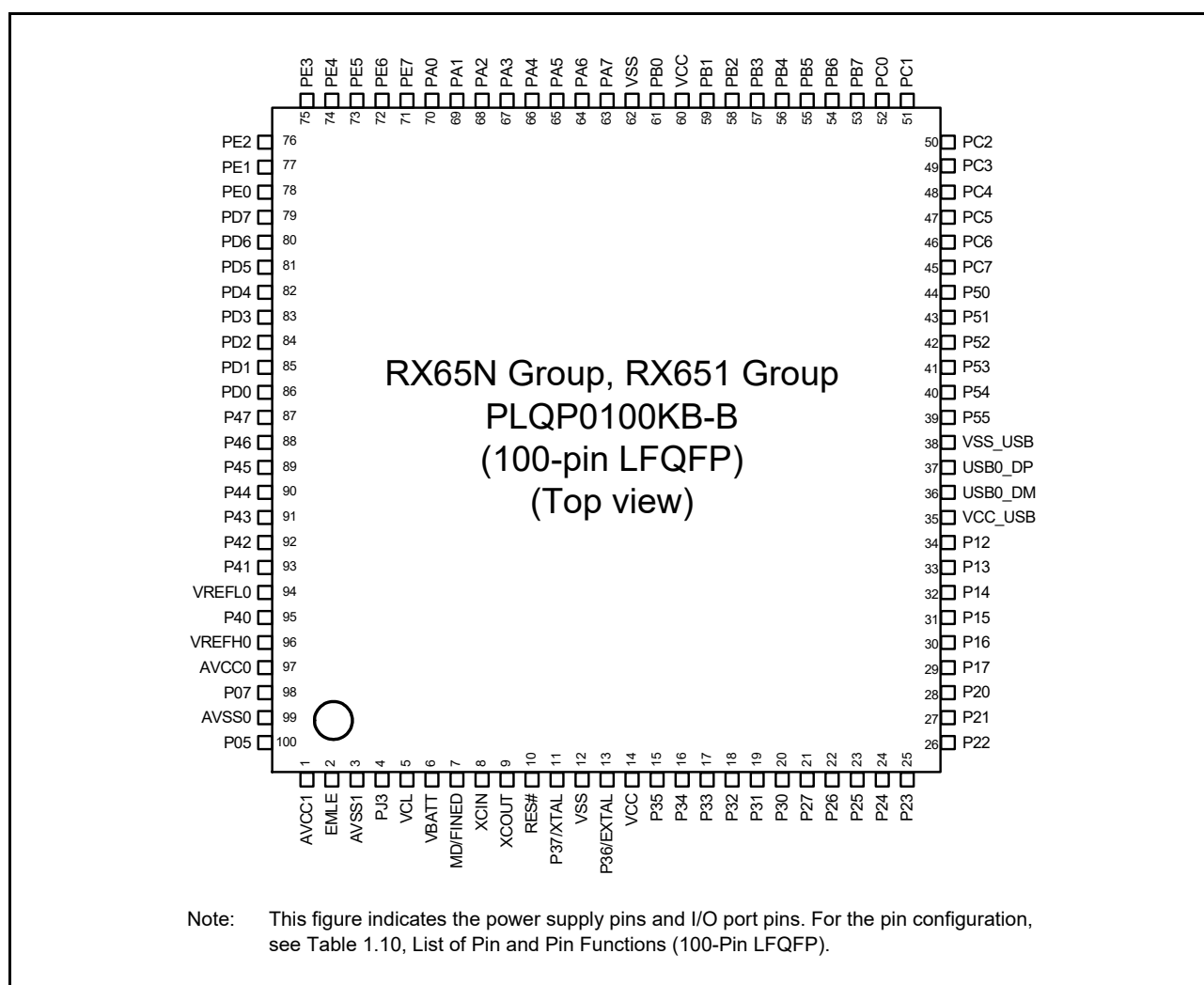
**Figure 1.9 Pin Assignment (100-Pin LQFP)**

Table 1.5 List of Pin and Pin Functions (177-Pin TFLGA, 176-Pin LFBGA) (3/8)

Pin Number	Power Supply Clock System Control	I/O Port	Bus EXDMAC SDRAMC	Timer (MTU, TPU, TMR, PPG, RTC, CMTW, POE, CAC)	Communication (ETHERC, SCI, RSPI, RIIC, CAN, USB)	Memory Interface Camera Interface (QSPI, SDHI, SDI, MMCIF, PDC)	GLCDC	Interrupt	A/D D/A
D14		PE7	D15[A15/ D15]/D7[A7/ D7]	MTIOC6A/ TOC1	MISOB-B	SDHI_WP/ MMC_RES#-B	LCD_DA TA9-B	IRQ7	AN105
D15		P65	CKE/CS5#						
E1		PJ5		POE8#	CTS2#/RTS2#/ SS2#				
E2	EMLE								
E3		PF5						IRQ4	
E4	VSS								
E5 *1	NC								
E12		PE6	D14[A14/ D14]/D6[A6/ D6]	MTIOC6C/TIC1	MOSIB-B	SDHI_CD/ MMC_CD-B	LCD_DA TA10-B	IRQ6	AN104
E13	TRDATA0	PG2	D26						
E14	TRDATA1	PG3	D27						
E15		P67	DQM1/CS7#	MTIOC7C				IRQ15	
F1	VBATT								
F2	VCL								
F3		PJ3	EDACK1	MTIOC3C	ET0_EXOUT/ CTS6#/RTS6#/ SS6#/CTS0#/ RTS0#/SS0#				
F4	BSCANP								
F12		P66	DQM0/CS6#	MTIOC7D					
F13	TRSYNC	PG4	D28						
F14		PA0	DQM2/ BC0#/A0	MTIOC4A/ MTIOC6D/ TIOCA0/PO16/ CACREF	ET0_TX_EN/ RMII0_TXD_EN/ SSLA1-B		LCD_DA TA8-B		
F15	VSS								
G1	XCIN								
G2	XCOUT								
G3	MD/FINED								
G4	TRST#	PF4							
G12	TRCLK	PG5	D29						
G13	TRDATA2	PG6	D30						
G14		PA1	DQM3/A1	MTIOC0B/ MTCLKC/ MTIOC7B/ TIOCB0/PO17	ET0_WOL/ SCK5/SSLA2-B		LCD_DA TA7-B	IRQ11	
G15	VCC								
H1	XTAL	P37							
H2	VSS								
H3	RES#								
H4	UPSEL	P35						NMI	
H12		PA4	A4	MTIC5U/ MTCLKA/ TIOCA1/ TMRI0/PO20	ET0_MDC/TXD5/ SMOSI5/SSDA5/ SSLA0-B		LCD_DA TA4-B	IRQ5-DS	

Table 1.5 List of Pin and Pin Functions (177-Pin TFLGA, 176-Pin LFBGA) (8/8)

Pin Number 177-Pin TFLGA 176-Pin LFBGA	Power Supply Clock System Control	I/O Port	Bus EXDMAC SDRAMC	Timer (MTU, TPU, TMR, PPG, RTC, CMTW, POE, CAC)	Communication (ETHERC, SCI, RSPI, RIIC, CAN, USB)	Memory Interface Camera Interface (QSPI, SDHI, SDSDI, MMCIF, PDC)	GLCDC	Interrupt	A/D D/A
R9		P53*2	BCLK						
R10	VSS								
R11	VCC								
R12		P80	EDREQ0	MTIOC3B/ PO26	ET0_TX_EN/ RMII0_TXD_EN/ SCK10/RTS10#	QIO2-A/SDHI_WP/ MMC_D2-A	LCD_DA TA14-A		
R13		P76	CS6#	PO22	ET0_RX_CLK/ REF50CK0/ SMISO11/ SSCL11/RXD11	QSSL-A/ SDHI_CMD-A/ SDSI_CMD-A/ MMC_CMD-A	LCD_DA TA18-A		
R14		P74	A20/CS4#	PO19	ET0_ERXD1/ RMII0_RXD1/ SS11#/CTS11#		LCD_DA TA21-A		
R15		PC1	A17	MTIOC3A/ TCLKD/PO18	ET0_ERXD2/ SCK5/SSLA2-A		LCD_DA TA22-A	IRQ12	

Note 1. The 176-pin LFBGA does not include the E5 pin.

Note 2. P53 is multiplexed with the BCLK pin function, so cannot be used as an I/O port pin when the external bus is enabled.

Table 1.10 List of Pin and Pin Functions (100-Pin LFQFP) (3/5)

Pin Number	Power Supply Clock System Control	I/O Port	Bus EXDMAC SDRAMC	Timer (MTU, TPU, TMR, PPG, RTC, CMTW, POE, CAC)	Communication (ETHERC, SCI, RSPI, RIIC, CAN, USB)	Memory Interface Camera Interface (QSPI, SDHI, SDSDI, MMCIF, PDC)	GLCDC	Interrupt	A/D D/A
45	UB	PC7	A23/CS0#	MTIOC3A/ MTCLKB/ TMO2/PO31/ TOC0/ CACREF	ET0_COL/TXD8/ SMOSI8/SSDA8/ SMOSI10/ SSDA10/TXD10/ MISOA-A			IRQ14	
46		PC6	D2[A2/D2]*1/ A22/CS1#	MTIOC3C/ MTCLKA/ TMCI2/PO30/ TIC0	ET0_ETXD3/ RXD8/SMISO8/ SSCL8/ SMISO10/ SSCL10/RXD10/ MOSIA-A			IRQ13	
47		PC5	D3[A3/D3]*1/ A21/CS2#/ WAIT#	MTIOC3B/ MTCLKD/ TMRI2/PO29	ET0_ETXD2/ SCK8/SCK10/ RSPCKA-A				
48		PC4	A20/CS3#	MTIOC3D/ MTCLKC/ TMCI1/PO25/ POE0#	ET0_TX_CLK/ SCK5/CTS8#/ RTS8#/SS8#/ SS10#/CTS10#/ RTS10#/SSLA0-A				
49		PC3	A19	MTIOC4D/ TCLKB/PO24	ET0_TX_ER/ TXD5/SMOSI5/ SSDA5				
50		PC2	A18	MTIOC4B/ TCLKA/PO21	ET0_RX_DV/ RXD5/SMISO5/ SSCL5/SSLA3-A				
51		PC1	A17	MTIOC3A/ TCLKD/PO18	ET0_ERXD2/ SCK5/SSLA2-A			IRQ12	
52		PC0	A16	MTIOC3C/ TCLKC/PO17	ET0_ERXD3/ CTS5#/RTS5#/ SS5#/SSLA1-A			IRQ14	
53		PB7	A15	MTIOC3B/ TIOCB5/PO31	ET0_CRS/ RMII0_CRS_DV/ TXD9/SMOSI9/ SSDA9/ SMOSI11/ SSDA11/TXD11	SDSI_D1-B			
54		PB6	A14	MTIOC3D/ TIOCA5/PO30	ET0_ETXD1/ RMII0_TXD1/ RXD9/SMISO9/ SSCL9/ SMISO11/ SSCL11/RXD11	SDSI_D0-B			
55		PB5	A13	MTIOC2A/ MTIOC1B/ TIOCB4/ TMRI1/PO29/ POE4#	ET0_ETXD0/ RMII0_TXD0/ SCK9/SCK11	SDSI_CLK-B	LCD_CL K-B*1		
56		PB4	A12	TIOCA4/PO28	ET0_TX_EN/ RMII0_TXD_EN/ CTS9#/RTS9#/ SS9#/SS11#/ CTS11#/RTS11#	SDSI_CMD-B	LCD_TC ON0-B*1		
57		PB3	A11	MTIOC0A/ MTIOC4A/ TIOCD3/ TCLKD/TMO0/ PO27/POE11#	ET0_RX_ER/ RMII0_RX_ER/ SCK6	SDSI_D3-B	LCD_TC ON1-B*1		
58		PB2	A10	TIOCC3/ TCLKC/PO26	ET0_RX_CLK/ REF50CK0/ CTS6#/RTS6#/ SS6#	SDSI_D2-B	LCD_TC ON2-B*1		
59		PB1	A9	MTIOC0C/ MTIOC4C/ TIOCB3/ TMCI0/PO25	ET0_ERXD0/ RMII0_RXD0/ TXD6/SMOSI6/ SSDA6		LCD_TC ON3-B*1	IRQ4-DS	

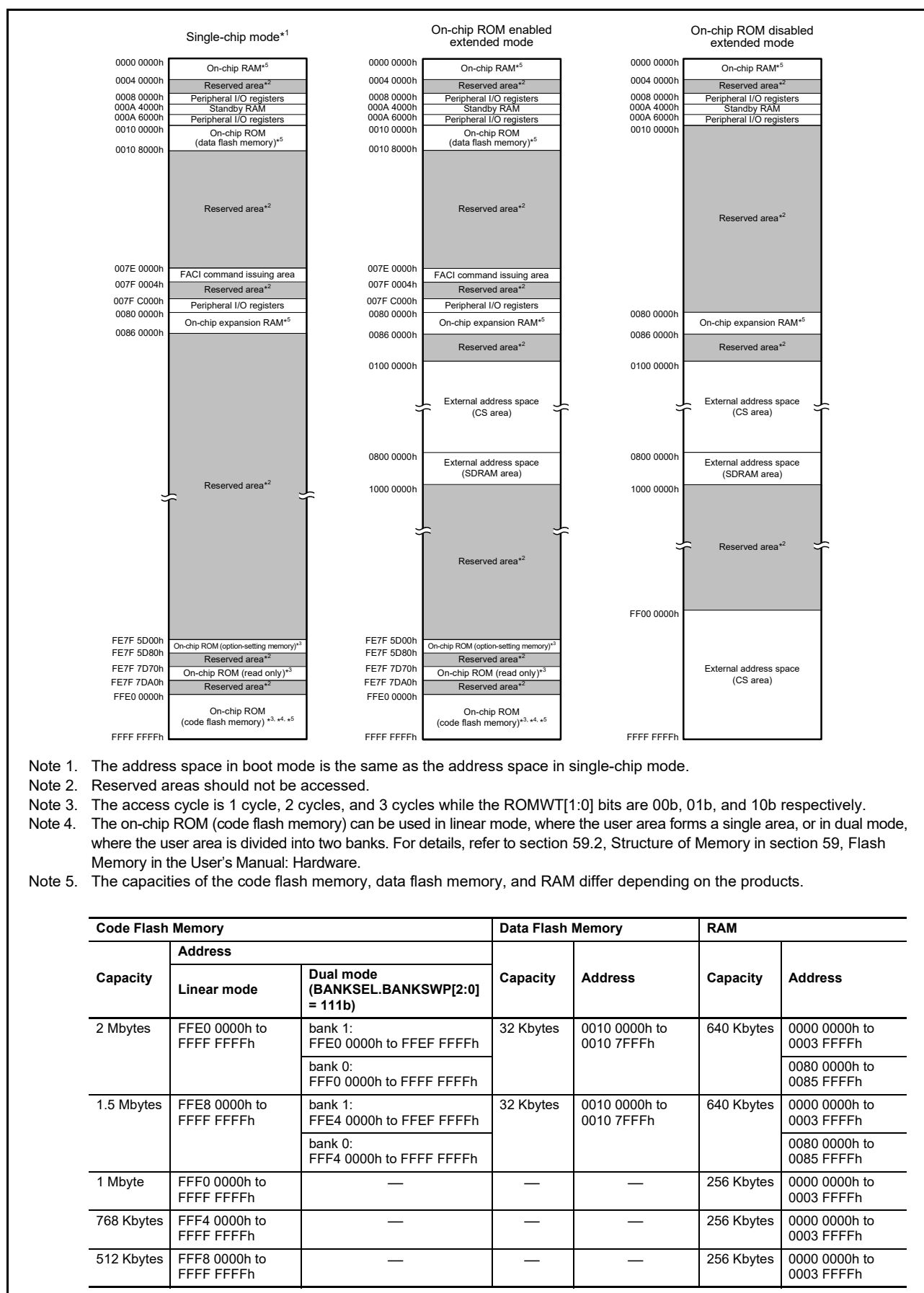


Figure 3.1 Memory Map in Each Operating Mode

Table 4.1 List of I/O Registers (Address Order) (31 / 61)

Address	Module Symbol	Register Name	Register Symbol	Number of Bits	Access Size	Number of Access Cycles		Related Function
						ICLK ≥ PCLK	ICLK < PCLK	
0008 A111h	SCI8	Receive Data Register L	RDRL	8	8	2, 3 PCLKB	2 ICLK	SCIg, SC1h, SC1i
0008 A110h	SCI8	Receive Data Register HL	RDRHL	16	16	4, 5 PCLKB	2 ICLK	SCIg, SC1h, SC1i
0008 A112h	SCI8	Modulation Duty Register	MDDR	8	8	2, 3 PCLKB	2 ICLK	SCIg, SC1h, SC1i
0008 A120h	SCI9	Serial Mode Register	SMR	8	8	2, 3 PCLKB	2 ICLK	SCIg, SC1h, SC1i
0008 A121h	SCI9	Bit Rate Register	BRR	8	8	2, 3 PCLKB	2 ICLK	SCIg, SC1h, SC1i
0008 A122h	SCI9	Serial Control Register	SCR	8	8	2, 3 PCLKB	2 ICLK	SCIg, SC1h, SC1i
0008 A123h	SCI9	Transmit Data Register	TDR	8	8	2, 3 PCLKB	2 ICLK	SCIg, SC1h, SC1i
0008 A124h	SCI9	Serial Status Register	SSR	8	8	2, 3 PCLKB	2 ICLK	SCIg, SC1h, SC1i
0008 A125h	SCI9	Receive Data Register	RDR	8	8	2, 3 PCLKB	2 ICLK	SCIg, SC1h, SC1i
0008 A126h	SMCI9	Smart Card Mode Register	SCMR	8	8	2, 3 PCLKB	2 ICLK	SCIg, SC1h, SC1i
0008 A127h	SCI9	Serial Extended Mode Register	SEMR	8	8	2, 3 PCLKB	2 ICLK	SCIg, SC1h, SC1i
0008 A128h	SCI9	Noise Filter Setting Register	SNFR	8	8	2, 3 PCLKB	2 ICLK	SCIg, SC1h, SC1i
0008 A129h	SCI9	I ² C Mode Register 1	SIMR1	8	8	2, 3 PCLKB	2 ICLK	SCIg, SC1h, SC1i
0008 A12Ah	SCI9	I ² C Mode Register 2	SIMR2	8	8	2, 3 PCLKB	2 ICLK	SCIg, SC1h, SC1i
0008 A12Bh	SCI9	I ² C Mode Register 3	SIMR3	8	8	2, 3 PCLKB	2 ICLK	SCIg, SC1h, SC1i
0008 A12Ch	SCI9	I ² C Status Register	SISR	8	8	2, 3 PCLKB	2 ICLK	SCIg, SC1h, SC1i
0008 A12Dh	SCI9	SPI Mode Register	SPMR	8	8	2, 3 PCLKB	2 ICLK	SCIg, SC1h, SC1i
0008 A12Eh	SCI9	Transmit Data Register H	TDRH	8	8	2, 3 PCLKB	2 ICLK	SCIg, SC1h, SC1i
0008 A12Fh	SCI9	Transmit Data Register L	TDRL	8	8	2, 3 PCLKB	2 ICLK	SCIg, SC1h, SC1i
0008 A12Eh	SCI9	Transmit Data Register HL	TDRHL	16	16	4, 5 PCLKB	2 ICLK	SCIg, SC1h, SC1i
0008 A130h	SCI9	Receive Data Register H	RDRH	8	8	2, 3 PCLKB	2 ICLK	SCIg, SC1h, SC1i
0008 A131h	SCI9	Receive Data Register L	RDRL	8	8	2, 3 PCLKB	2 ICLK	SCIg, SC1h, SC1i
0008 A130h	SCI9	Receive Data Register HL	RDRHL	16	16	4, 5 PCLKB	2 ICLK	SCIg, SC1h, SC1i

Table 4.1 List of I/O Registers (Address Order) (42 / 61)

Address	Module Symbol	Register Name	Register Symbol	Number of Bits	Access Size	Number of Access Cycles		Related Function
						ICLK ≥ PCLK	ICLK < PCLK	
0008 C282h	SYSTEM	Deep Standby Interrupt Enable Register 0	DPSIER0	8	8	4, 5 PCLKB	2, 3 ICLK	Low Power Consumption
0008 C283h	SYSTEM	Deep Standby Interrupt Enable Register 1	DPSIER1	8	8	4, 5 PCLKB	2, 3 ICLK	Low Power Consumption
0008 C284h	SYSTEM	Deep Standby Interrupt Enable Register 2	DPSIER2	8	8	4, 5 PCLKB	2, 3 ICLK	Low Power Consumption
0008 C285h	SYSTEM	Deep Standby Interrupt Enable Register 3	DPSIER3	8	8	4, 5 PCLKB	2, 3 ICLK	Low Power Consumption
0008 C286h	SYSTEM	Deep Standby Interrupt Flag Register 0	DPSIFR0	8	8	4, 5 PCLKB	2, 3 ICLK	Low Power Consumption
0008 C287h	SYSTEM	Deep Standby Interrupt Flag Register 1	DPSIFR1	8	8	4, 5 PCLKB	2, 3 ICLK	Low Power Consumption
0008 C288h	SYSTEM	Deep Standby Interrupt Flag Register 2	DPSIFR2	8	8	4, 5 PCLKB	2, 3 ICLK	Low Power Consumption
0008 C289h	SYSTEM	Deep Standby Interrupt Flag Register 3	DPSIFR3	8	8	4, 5 PCLKB	2, 3 ICLK	Low Power Consumption
0008 C28Ah	SYSTEM	Deep Standby Interrupt Edge Register 0	DPSIEGR0	8	8	4, 5 PCLKB	2, 3 ICLK	Low Power Consumption
0008 C28Bh	SYSTEM	Deep Standby Interrupt Edge Register 1	DPSIEGR1	8	8	4, 5 PCLKB	2, 3 ICLK	Low Power Consumption
0008 C28Ch	SYSTEM	Deep Standby Interrupt Edge Register 2	DPSIEGR2	8	8	4, 5 PCLKB	2, 3 ICLK	Low Power Consumption
0008 C28Dh	SYSTEM	Deep Standby Interrupt Edge Register 3	DPSIEGR3	8	8	4, 5 PCLKB	2, 3 ICLK	Low Power Consumption
0008 C290h	SYSTEM	Reset Status Register 0	RSTSR0	8	8	4, 5 PCLKB	2, 3 ICLK	Resets
0008 C291h	SYSTEM	Reset Status Register 1	RSTSR1	8	8	4, 5 PCLKB	2, 3 ICLK	Resets
0008 C293h	SYSTEM	Main Clock Oscillator Forced Oscillation Control Register	MOFCR	8	8	4, 5 PCLKB	2, 3 ICLK	Clock Generation Circuit
0008 C294h	SYSTEM	High-Speed On-Chip Oscillator Power Supply Control Register	HOCOPCR	8	8	4, 5 PCLKB	2, 3 ICLK	Clock Generation Circuit
0008 C296h	FLASH	Flash P/E Protect Register	FWEPROR	8	8	2 ICLK		Flash
0008 C297h	SYSTEM	Voltage Monitoring Circuit Control Register	LVCMPCR	8	8	4, 5 PCLKB	2, 3 ICLK	LVDA
0008 C298h	SYSTEM	Voltage Detection Level Select Register	LVDLVL	8	8	4, 5 PCLKB	2, 3 ICLK	LVDA
0008 C29Ah	SYSTEM	Voltage Monitoring 1 Circuit Control Register 0	LVD1CR0	8	8	4, 5 PCLKB	2, 3 ICLK	LVDA
0008 C29Bh	SYSTEM	Voltage Monitoring 2 Circuit Control Register 0	LVD2CR0	8	8	4, 5 PCLKB	2, 3 ICLK	LVDA

Table 4.1 List of I/O Registers (Address Order) (51 / 61)

Address	Module Symbol	Register Name	Register Symbol	Number of Bits	Access Size	Number of Access Cycles		Related Function
						ICLK ≥ PCLK	ICLK < PCLK	
000C 01F8h	ETHER C0	Multicast Address Frame Receive Counter Register	MAFCR	32	32	13, 14 PCLKA	1 to 7 ICLK	ETHER C
000C 1200h	MTU3	Timer Control Register	TCR	8	8	4, 5 PCLKA	1, 2 ICLK	MTU3a
000C 1201h	MTU4	Timer Control Register	TCR	8	8	4, 5 PCLKA	1, 2 ICLK	MTU3a
000C 1202h	MTU3	Timer Mode Register 1	TMDR1	8	8	4, 5 PCLKA	1, 2 ICLK	MTU3a
000C 1203h	MTU4	Timer Mode Register 1	TMDR1	8	8	4, 5 PCLKA	1, 2 ICLK	MTU3a
000C 1204h	MTU3	Timer I/O Control Register H	TIORH	8	8	4, 5 PCLKA	1, 2 ICLK	MTU3a
000C 1205h	MTU3	Timer I/O Control Register L	TIORL	8	8	4, 5 PCLKA	1, 2 ICLK	MTU3a
000C 1206h	MTU4	Timer I/O Control Register H	TIORH	8	8	4, 5 PCLKA	1, 2 ICLK	MTU3a
000C 1207h	MTU4	Timer I/O Control Register L	TIORL	8	8	4, 5 PCLKA	1, 2 ICLK	MTU3a
000C 1208h	MTU3	Timer Interrupt Enable Register	TIER	8	8	4, 5 PCLKA	1, 2 ICLK	MTU3a
000C 1209h	MTU4	Timer Interrupt Enable Register	TIER	8	8	4, 5 PCLKA	1, 2 ICLK	MTU3a
000C 120Ah	MTU	Timer Output Master Enable Register A	TOERA	8	8	4, 5 PCLKA	1, 2 ICLK	MTU3a
000C 120Dh	MTU	Timer Gate Control Register A	TGCRA	8	8	4, 5 PCLKA	1, 2 ICLK	MTU3a
000C 120Eh	MTU	Timer Output Control Register 1A	TOCR1A	8	8	4, 5 PCLKA	1, 2 ICLK	MTU3a
000C 120Fh	MTU	Timer Output Control Register 2A	TOCR2A	8	8	4, 5 PCLKA	1, 2 ICLK	MTU3a
000C 1210h	MTU3	Timer Counter	TCNT	16	16	4, 5 PCLKA	1, 2 ICLK	MTU3a
000C 1212h	MTU4	Timer Counter	TCNT	16	16	4, 5 PCLKA	1, 2 ICLK	MTU3a
000C 1214h	MTU	Timer Cycle Data Register A	TCDRA	16	16	4, 5 PCLKA	1, 2 ICLK	MTU3a
000C 1216h	MTU	Timer Dead Time Data Register A	TDDRA	16	16	4, 5 PCLKA	1, 2 ICLK	MTU3a
000C 1218h	MTU3	Timer General Register A	TGRA	16	16	4, 5 PCLKA	1, 2 ICLK	MTU3a
000C 121Ah	MTU3	Timer General Register B	TGRB	16	16	4, 5 PCLKA	1, 2 ICLK	MTU3a
000C 121Ch	MTU4	Timer General Register A	TGRA	16	16	4, 5 PCLKA	1, 2 ICLK	MTU3a
000C 121Eh	MTU4	Timer General Register B	TGRB	16	16	4, 5 PCLKA	1, 2 ICLK	MTU3a
000C 1220h	MTU	Timer Subcounter A	TCNTSA	16	16	4, 5 PCLKA	1, 2 ICLK	MTU3a
000C 1222h	MTU	Timer Cycle Buffer Register A	TCBRA	16	16	4, 5 PCLKA	1, 2 ICLK	MTU3a
000C 1224h	MTU3	Timer General Register C	TGRC	16	16	4, 5 PCLKA	1, 2 ICLK	MTU3a
000C 1226h	MTU3	Timer General Register D	TGRD	16	16	4, 5 PCLKA	1, 2 ICLK	MTU3a
000C 1228h	MTU4	Timer General Register C	TGRC	16	16	4, 5 PCLKA	1, 2 ICLK	MTU3a
000C 122Ah	MTU4	Timer General Register D	TGRD	16	16	4, 5 PCLKA	1, 2 ICLK	MTU3a
000C 122Ch	MTU3	Timer Status Register	TSR	8	8	4, 5 PCLKA	1, 2 ICLK	MTU3a
000C 122Dh	MTU4	Timer Status Register	TSR	8	8	4, 5 PCLKA	1, 2 ICLK	MTU3a
000C 1230h	MTU	Timer Interrupt Skipping Set Register 1A	TITCR1A	8	8	4, 5 PCLKA	1, 2 ICLK	MTU3a
000C 1231h	MTU	Timer Interrupt Skipping Counter 1A	TITCNT1A	8	8	4, 5 PCLKA	1, 2 ICLK	MTU3a
000C 1232h	MTU	Timer Buffer Transfer Set Register A	TBTERA	8	8	4, 5 PCLKA	1, 2 ICLK	MTU3a
000C 1234h	MTU	Timer Dead Time Enable Register A	TDERA	8	8	4, 5 PCLKA	1, 2 ICLK	MTU3a
000C 1236h	MTU	Timer Output Level Buffer Register A	TOLBRA	8	8	4, 5 PCLKA	1, 2 ICLK	MTU3a
000C 1238h	MTU3	Timer Buffer Operation Transfer Mode Register	TBTM	8	8	4, 5 PCLKA	1, 2 ICLK	MTU3a
000C 1239h	MTU4	Timer Buffer Operation Transfer Mode Register	TBTM	8	8	4, 5 PCLKA	1, 2 ICLK	MTU3a
000C 123Ah	MTU	Timer Interrupt Skipping Mode Register A	TITMRA	8	8	4, 5 PCLKA	1, 2 ICLK	MTU3a
000C 123Bh	MTU	Timer Interrupt Skipping Set Register 2A	TITCR2A	8	8	4, 5 PCLKA	1, 2 ICLK	MTU3a
000C 123Ch	MTU	Timer Interrupt Skipping Counter 2A	TITCNT2A	8	8	4, 5 PCLKA	1, 2 ICLK	MTU3a
000C 1240h	MTU4	Timer A/D Converter Start Request Control Register	TADCR	16	16	4, 5 PCLKA	1, 2 ICLK	MTU3a
000C 1244h	MTU4	Timer A/D Converter Start Request Cycle Set Register A	TADCORA	16	16	4, 5 PCLKA	1, 2 ICLK	MTU3a
000C 1246h	MTU4	Timer A/D Converter Start Request Cycle Set Register B	TADCORB	16	16	4, 5 PCLKA	1, 2 ICLK	MTU3a
000C 1248h	MTU4	Timer A/D Converter Start Request Cycle Set Buffer Register A	TADCOBRA	16	16	4, 5 PCLKA	1, 2 ICLK	MTU3a
000C 124Ah	MTU4	Timer A/D Converter Start Request Cycle Set Buffer Register B	TADCOBRB	16	16	4, 5 PCLKA	1, 2 ICLK	MTU3a
000C 124Ch	MTU3	Timer Control Register 2	TCR2	8	8	4, 5 PCLKA	1, 2 ICLK	MTU3a

Note 6. The low power consumption function is enabled and DEEPCUT[1:0] = 11b.

Note 7. Reference value

Table 5.6 DC Characteristics (3) (Products for products with at least 1.5 Mbytes of code flash memory)

Conditions: VCC = AVCC0 = AVCC1 = VCC_USB = 2.7 to 3.6 V, 2.7 V ≤ VREFH0 ≤ AVCC0,

VSS = AVSS0 = AVSS1 = VREFL0 = VSS_USB = 0 V,

T_a = T_{opr}

Item			Symbol	D version		G version		Unit	Test Conditions			
				Typ.	Max.	Typ.	Max.					
Supply current*1	High-speed operating mode	Max.*2		I _{CC} *3	—	60	—	73	mA	ICLK = 120 MHz PCLKA = 120 MHz PCLKB = 60 MHz PCLKC = 60 MHz PCLKD = 60 MHz FCLK = 60 MHz BCLK = 120 MHz BCLK pin = 60 MHz		
		Normal	Peripheral function clock signal supplied*4		26	—	26	—				
			Peripheral function clock signal stopped*4		13	—	13	—				
		Core Mark	Peripheral function clock signal stopped*4		17	—	17	—				
			Sleep mode: The clock signal to peripheral modules is supplied*4		20	38	20	52				
		All-module-clock-stop mode (reference value)			9	26	9	39				
		Increased by BGO operation*7	Reading from the code flash memory while the data flash memory is being programmed		6	—	6	—				
			Reading from the code flash memory while the code flash memory is being programmed		7	—	7	—				
		Increased by Trusted Secure IP operation			—	12	—	12				
		Low-speed operating mode 1: Supply of the clock signal to peripheral modules is stopped*4			1.6	—	1.6	—				
		Low-speed operating mode 2: Supply of the clock signal to peripheral modules is stopped*4			1.6	—	1.6	—				
		Software standby mode			1.6	13	1.6	22.4				
	Deep software standby mode	Power supplied to standby RAM and USB resume detecting unit (USB0 only)		15.5	70	15.5	98	μA				
		Power not supplied to standby RAM and USB resume detecting unit (USB0 only)	Power-on reset circuit and low-power consumption function disabled*5	11.5	42	11.5	54					
			Power-on reset circuit and low-power consumption function enabled*6	4.9	32	4.9	47					
		Increased by RTC operation	When a low C _L crystal is in use	1	—	1	—					
			When a standard C _L crystal is in use	2	—	2	—					
		RTC operating while VCC is off (with the battery backup function, only the RTC and sub-clock oscillator operate)	When a crystal oscillator for low clock loads is in use	0.9	—	0.9	—					
				1.6	—	1.6	—					
			When a crystal oscillator for standard clock loads is in use	1.7	—	1.7	—					
				3.3	—	3.3	—					
		Inrush current on returning from deep software standby mode	Inrush current*8	I _{RUSH}	—	130	—			130	mA	
			Energy of inrush current*8	E _{RUSH}	—	1.0	—			1.0		

Note 1. Supply current values are with all output pins unloaded and all input pull-up MOSs in the off state.

Note 2. Supply of the clock signal to peripheral modules is stopped in this state.

Note 3. I_{CC} depends on f (ICLK) as follows. (ICLK/PCLKA:PCLKB/PCLKC/PCLKD:BCLK:BCLK pin = 10:5:10:5 when EXTAL = 12 MHz)

[D version]

I_{CC} Max. = 0.38 × f + 14 (max. operation in high-speed operating mode)

I_{CC} Typ. = 0.18 × f + 4 (ICLK 1 MHz max) (normal operation in high-speed operating mode)

I_{CC} Typ. = 0.4 × f + 1.2 (low-speed operating mode 1)

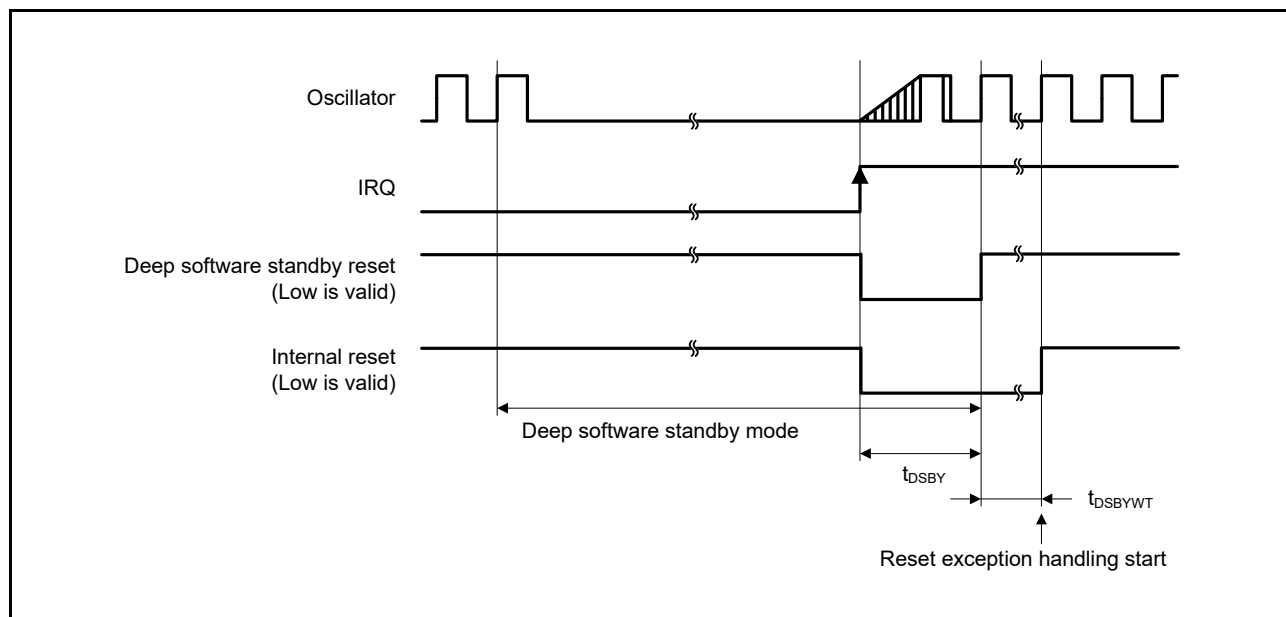
I_{CC} Max. = 0.2 × f + 14 (sleep mode)

[G version]

Table 5.22 Timing of Recovery from Low Power Consumption Modes (2)

Conditions: $V_{CC} = AVCC0 = AVCC1 = VCC_USB = V_{BATT} = 2.7$ to 3.6 V, 2.7 V $\leq VREFH0 \leq AVCC0$,
 $VSS = AVSS0 = AVSS1 = VREFL0 = VSS_USB = 0$ V,
 $T_a = T_{opr}$

Item	Symbol	Min.	Typ.	Max.	Unit	Test Conditions
Recovery time after cancellation of deep software standby mode	t_{DSBY}	—	—	0.9	ms	Figure 5.13
Wait time after cancellation of deep software standby mode	t_{DSBYWT}	23	—	24	t_{Lcyc}	

**Figure 5.13 Deep Software Standby Mode Cancellation Timing**

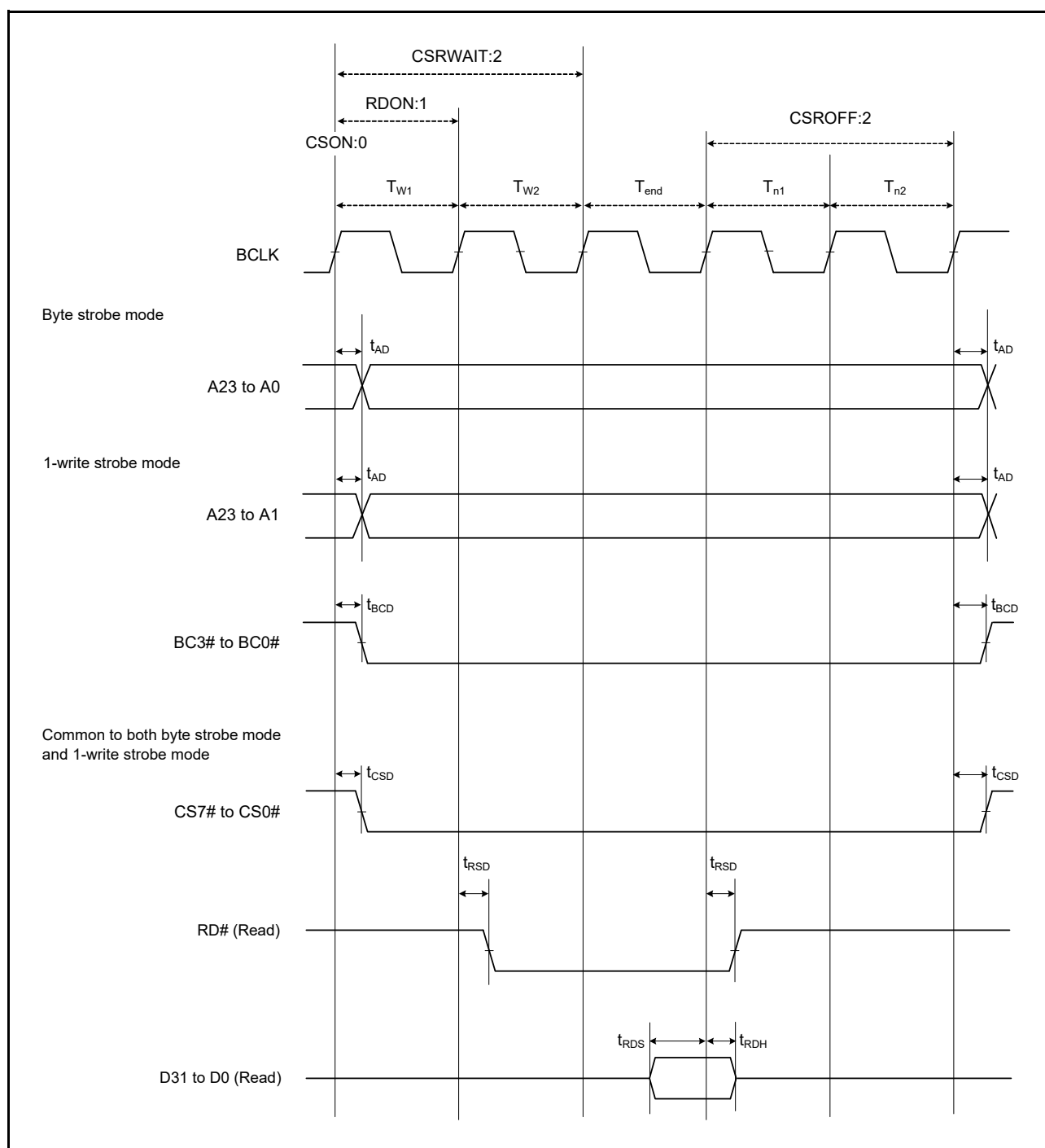


Figure 5.18 External Bus Timing/Normal Read Cycle (Bus Clock Synchronized)

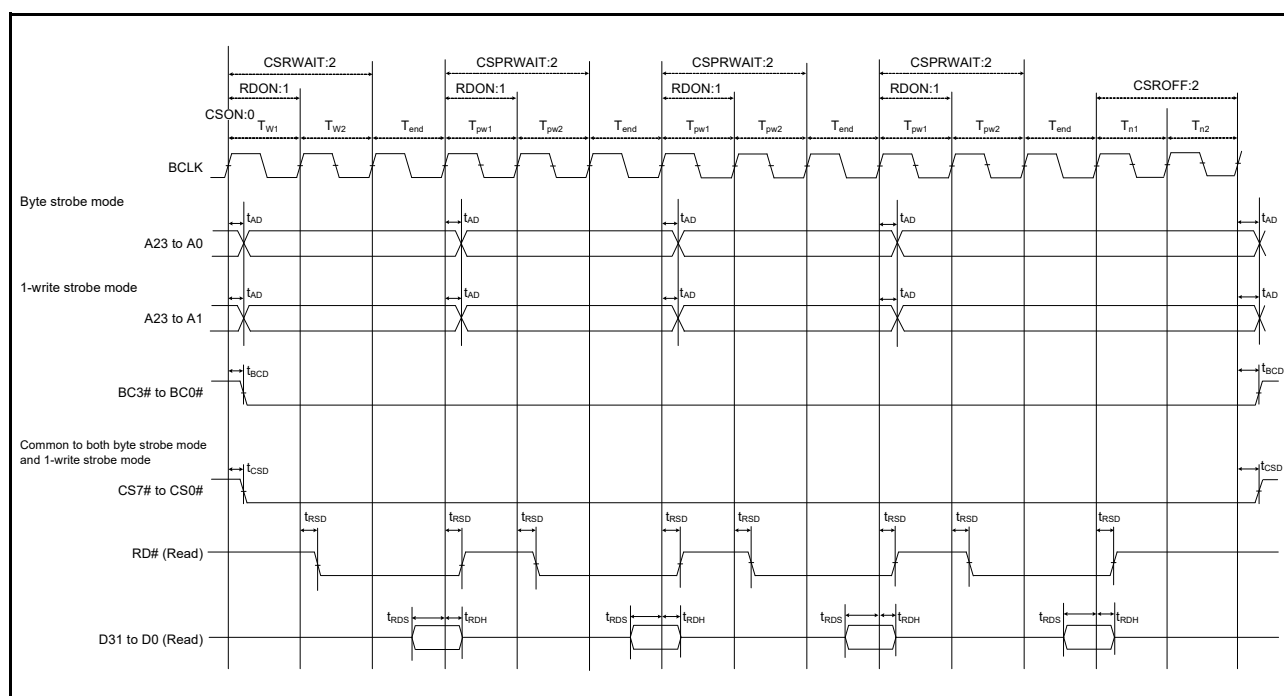


Figure 5.20 External Bus Timing/Page Read Cycle (Bus Clock Synchronized)

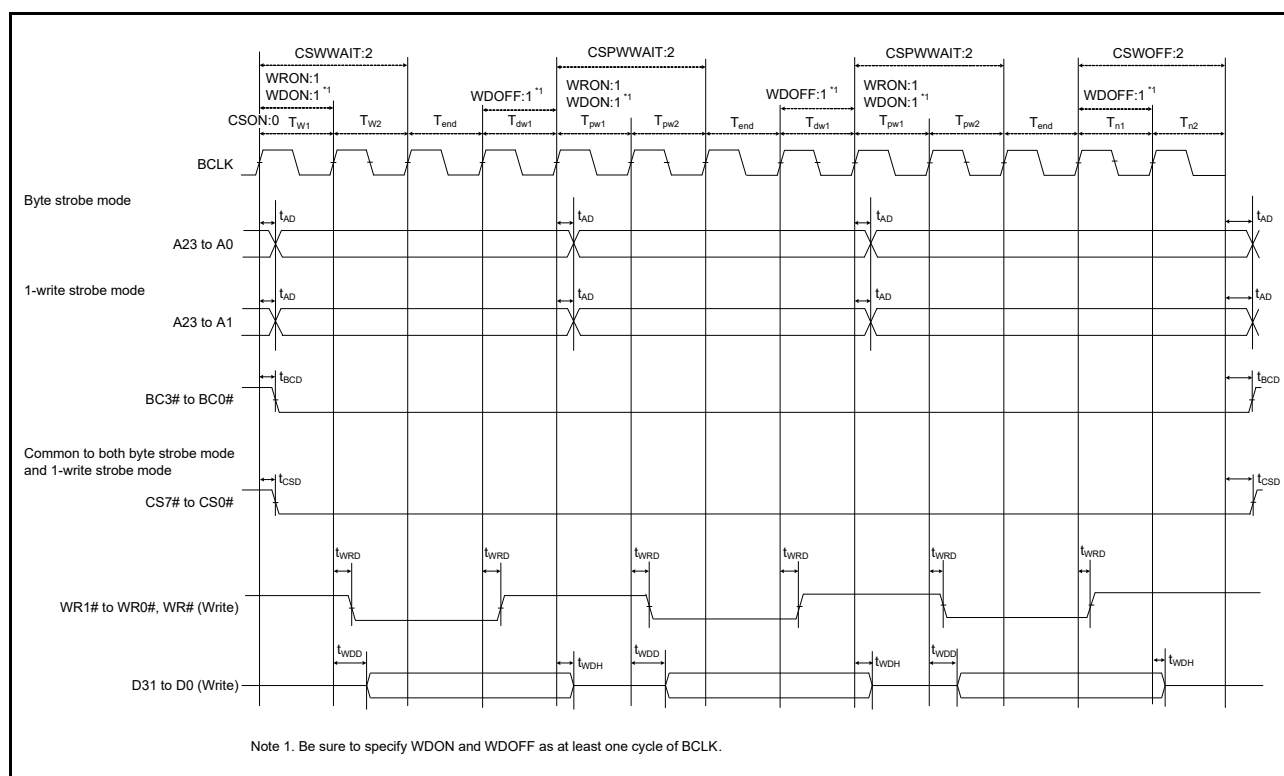


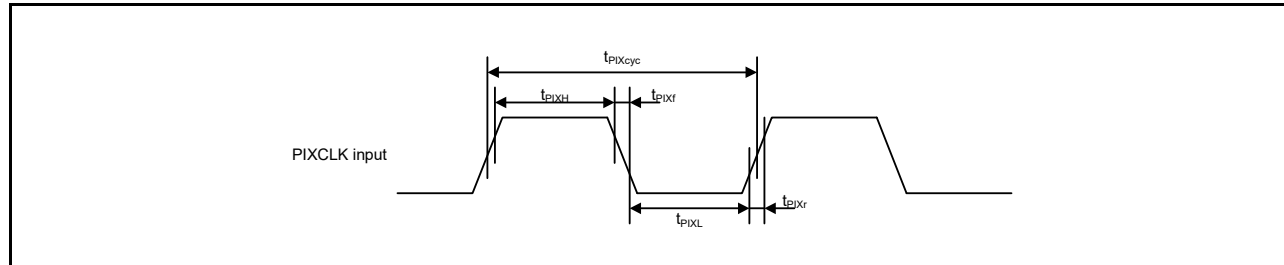
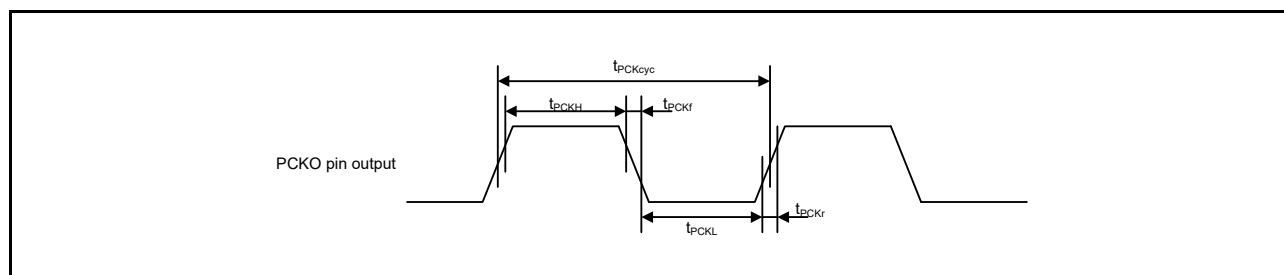
Figure 5.21 External Bus Timing/Page Write Cycle (Bus Clock Synchronized)

Table 5.42 PDC Timing

Conditions: $V_{CC} = AVCC0 = AVCC1 = V_{CC_USB} = V_{BATT} = 2.7$ to 3.6 V, 2.7 V $\leq V_{REFH0} \leq AVCC0$,
 $V_{SS} = AVSS0 = AVSS1 = V_{REFL0} = V_{SS_USB} = 0$ V,
 $PCLKA = 8$ to 120 MHz, $PCLKB = 8$ to 60 MHz, $T_a = T_{opr}$,
 Output load conditions: $V_{OH} = V_{CC} \times 0.5$, $V_{OL} = V_{CC} \times 0.5$, $C = 30$ pF,
 High-drive output is selected by the driving ability control register.

	Item	Symbol	Min.*1	Max.	Unit	Test Conditions
PDC	PIXCLK input cycle time	t_{PIXcyc}	37	—	ns	Figure 5.66
	PIXCLK input high pulse width	t_{PIXH}	10	—	ns	
	PIXCLK input low pulse width	t_{PIXL}	10	—	ns	
	PIXCLK rising time	t_{PIXr}	—	5	ns	
	PIXCLK falling time	t_{PIXf}	—	5	ns	
	PCKO output cycle time	t_{PCKcyc}	$2 \times t_{PBcyc}$	—	ns	Figure 5.67
	PCKO output high pulse width	t_{PCKH}	$(t_{PCKcyc} - t_{PCKr} - t_{PCKf})/2 - 3$	—	ns	
	PCKO output low pulse width	t_{PCKL}	$(t_{PCKcyc} - t_{PCKr} - t_{PCKf})/2 - 3$	—	ns	
	PCKO rising time	t_{PCKr}	—	5	ns	
	PCKO falling time	t_{PCKf}	—	5	ns	
	VSYNC/HSYNC input setup time	t_{SYNCS}	10	—	ns	Figure 5.68
	VSYNC/HSYNC input hold time	t_{SYNCH}	5	—	ns	
	PIXD input setup time	t_{PIXDS}	10	—	ns	
	PIXD input hold time	t_{PIXDH}	5	—	ns	

Note 1. t_{PBcyc} : PCLKB cycle

**Figure 5.66 PDC Input Clock Timing****Figure 5.67 PDC Output Clock Timing**

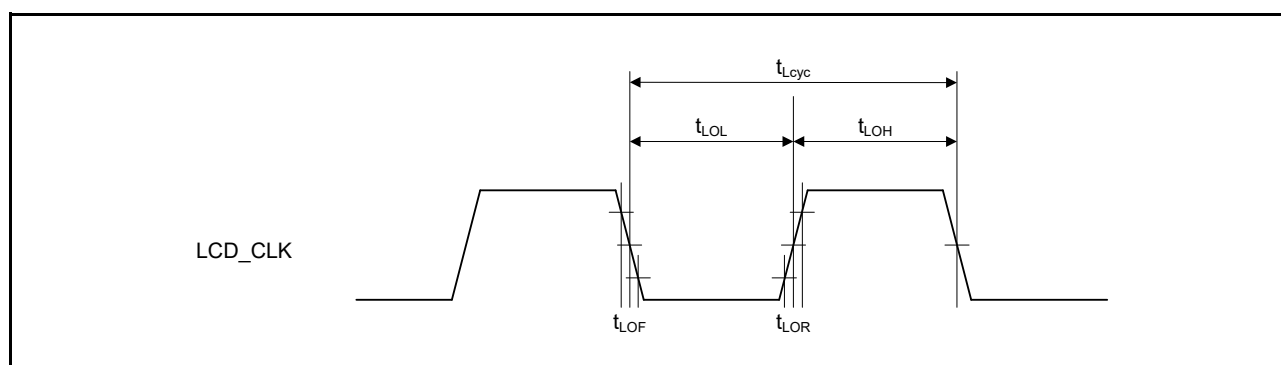


Figure 5.70 LCD_CLK Clock Output Timing

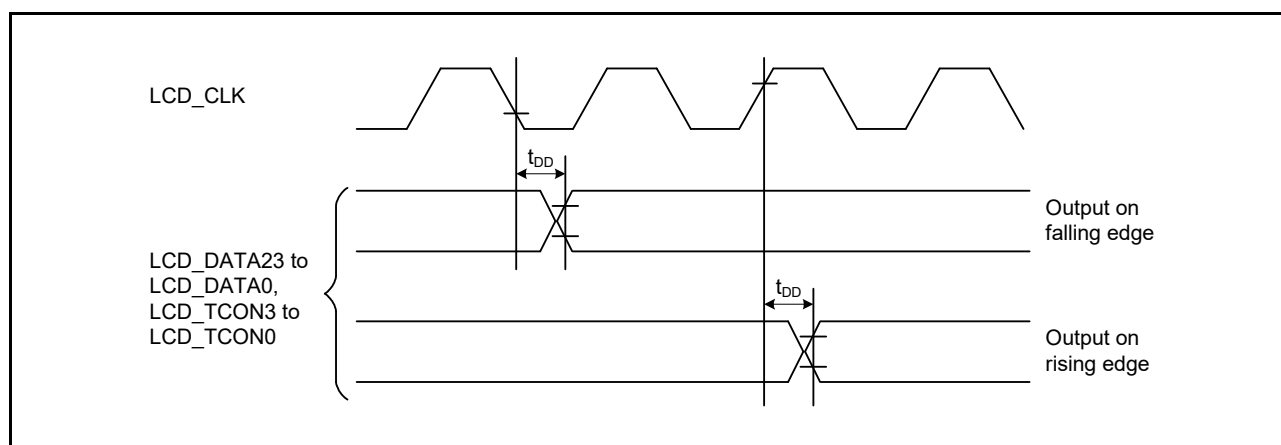


Figure 5.71 LCD Output Data Timing

Appendix 1. Package Dimensions

Information on the latest version of the package dimensions or mountings has been displayed in “Packages” on Renesas Electronics Corporation website.

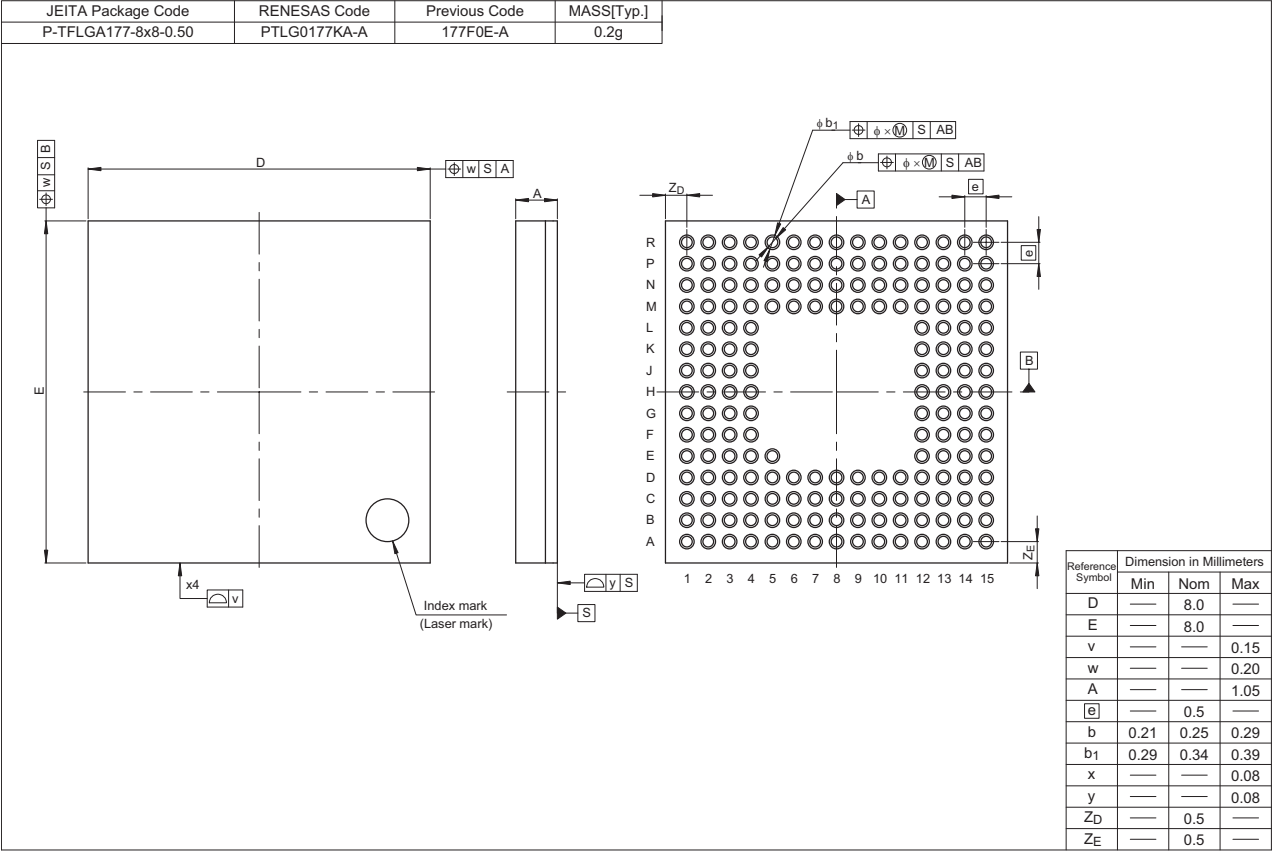


Figure A 177-Pin TFLGA (PTLG0177KA-A)

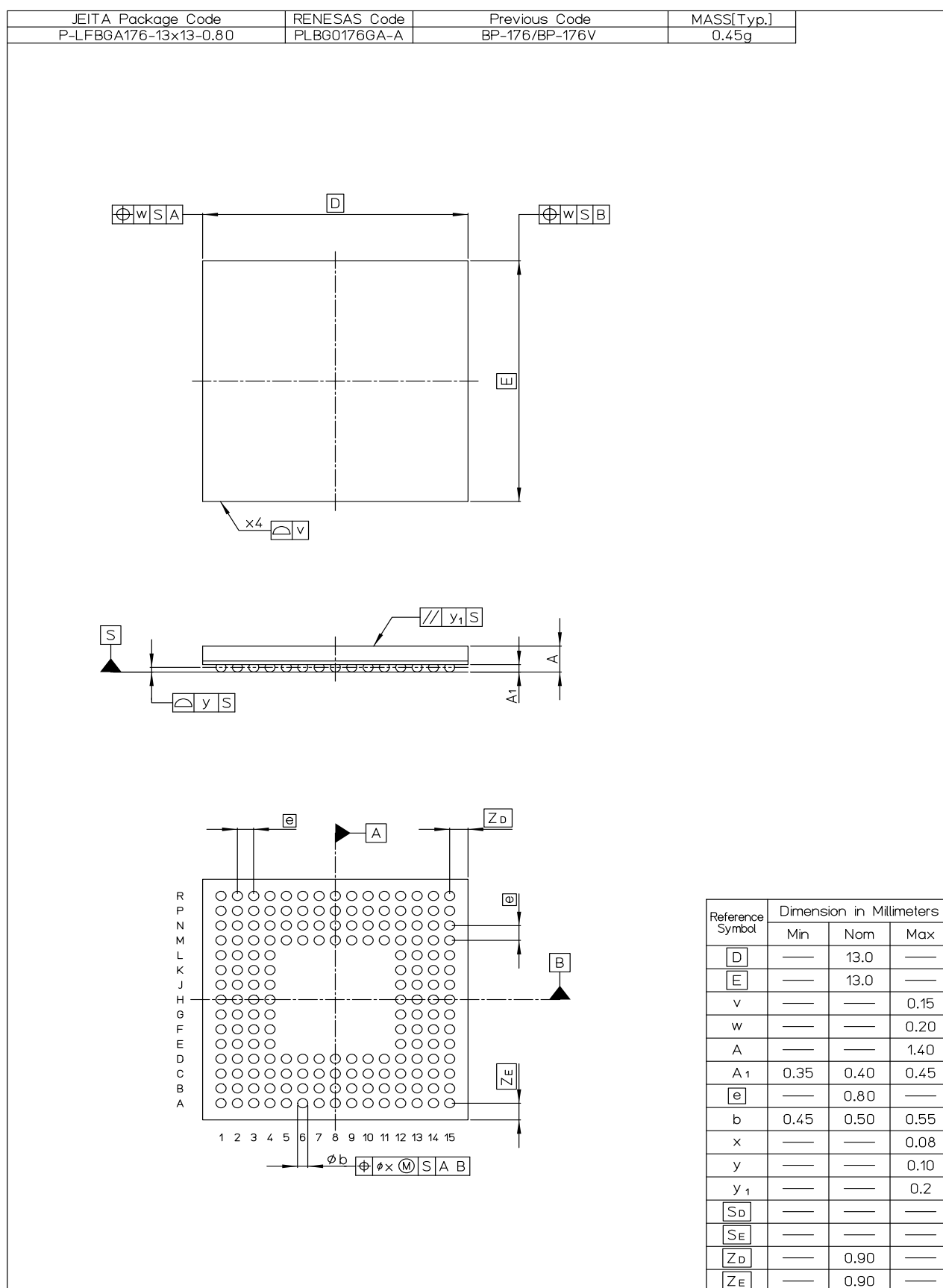


Figure B 176-Pin LFBGA (PLBG0176GA-A)

General Precautions in the Handling of Microprocessing Unit and Microcontroller Unit Products

The following usage notes are applicable to all Microprocessing unit and Microcontroller unit products from Renesas. For detailed usage notes on the products covered by this document, refer to the relevant sections of the document as well as any technical updates that have been issued for the products.

1. Handling of Unused Pins

Handle unused pins in accordance with the directions given under Handling of Unused Pins in the manual.

- ¾ The input pins of CMOS products are generally in the high-impedance state. In operation with an unused pin in the open-circuit state, extra electromagnetic noise is induced in the vicinity of LSI, an associated shoot-through current flows internally, and malfunctions occur due to the false recognition of the pin state as an input signal become possible. Unused pins should be handled as described under Handling of Unused Pins in the manual.

2. Processing at Power-on

The state of the product is undefined at the moment when power is supplied.

- ¾ The states of internal circuits in the LSI are indeterminate and the states of register settings and pins are undefined at the moment when power is supplied.
In a finished product where the reset signal is applied to the external reset pin, the states of pins are not guaranteed from the moment when power is supplied until the reset process is completed. In a similar way, the states of pins in a product that is reset by an on-chip power-on reset function are not guaranteed from the moment when power is supplied until the power reaches the level at which resetting has been specified.

3. Prohibition of Access to Reserved Addresses

Access to reserved addresses is prohibited.

- ¾ The reserved addresses are provided for the possible future expansion of functions. Do not access these addresses; the correct operation of LSI is not guaranteed if they are accessed.

4. Clock Signals

After applying a reset, only release the reset line after the operating clock signal has become stable. When switching the clock signal during program execution, wait until the target clock signal has stabilized.

- ¾ When the clock signal is generated with an external resonator (or from an external oscillator) during a reset, ensure that the reset line is only released after full stabilization of the clock signal. Moreover, when switching to a clock signal produced with an external resonator (or by an external oscillator) while program execution is in progress, wait until the target clock signal is stable.

5. Differences between Products

Before changing from one product to another, i.e. to a product with a different part number, confirm that the change will not lead to problems.

- ¾ The characteristics of Microprocessing unit or Microcontroller unit products in the same group but having a different part number may differ in terms of the internal memory capacity, layout pattern, and other factors, which can affect the ranges of electrical characteristics, such as characteristic values, operating margins, immunity to noise, and amount of radiated noise. When changing to a product with a different part number, implement a system-evaluation test for the given product.